# **Quad 2-Input NOR Gate With Strobe**

# Description

The MC10H100 is a quad NOR gate. Each gate has 3 inputs, two of which are independent and one of which is tied common to all four gates.

#### **Features**

- Propagation Delay, 1.0 ns Typical
- 25 mW Typ/Gate (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K<sup>TM</sup> Compatible
- Pb-Free Packages are Available\*



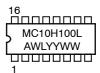
# ON Semiconductor®

http://onsemi.com

## **MARKING DIAGRAMS\***



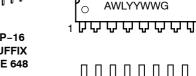
**L SUFFIX CASE 620** 



MC10H100P

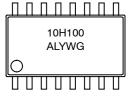


PDIP-16 **P SUFFIX CASE 648** 





SOEIAJ-16 **CASE 966** 



Α = Assembly Location

= Wafer Lot WL, L YY, Y = Year WW, W = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

# **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

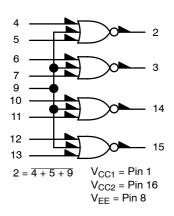
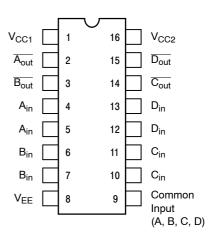


Figure 1. Logic Diagram



Pin assignment is for Dual-in-Line Package.

Figure 2. Pin Assignment

**Table 1. MAXIMUM RATINGS** 

Symbol	Characteristic		Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 0)		-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)		0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current	Continuous Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range		0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range	Plastic Ceramic	-55 to +150 -55 to +165	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS ( $V_{\text{EE}}$  = -5.2 V  $\pm 5\%$ ) (Note 1)

		C	<b>0</b> °		<b>25</b> °		<b>75</b> °	
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
IE	Power Supply Current	-	29	-	26	-	29	mA
I <sub>inH</sub>	Input Current High Pin 9 All Other Inputs		900 500	- -	560 310	_ _	560 310	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V <sub>IL</sub>	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

<sup>1.</sup> Each MECL 10H™ series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to −2.0 V.

**Table 3. AC CHARACTERISTICS** 

			<b>0</b> °		<b>25</b> °		<b>75</b> °		
Symbol	Characteristic		Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay	Pin 9 Only Exclude Pin 9	0.65 0.4	1.6 1.3	0.7 0.45	1.7 1.35	0.7 0.5	1.8 1.5	ns
t <sub>r</sub>	Rise Time		0.5	2.0	0.5	2.1	0.5	2.2	ns
t <sub>f</sub>	Fall Time		0.5	2.0	0.5	2.1	0.5	2.2	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

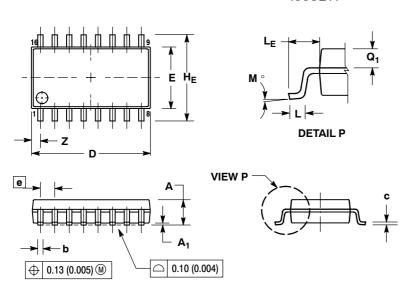
# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC10H100M	SOEIAJ-16	50 Unit / Rail
MC10H100MG	SOEIAJ-16 (Pb-Free)	50 Unit / Rail
MC10H100MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H100MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H100L	CDIP-16	25 Unit / Rail
MC10H100P	PDIP-16	25 Unit / Rail
MC10H100PG	PDIP-16 (Pb-Free)	25 Unit / Rail

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

# SOEIAJ-16 CASE 966-01 **ISSUE A**

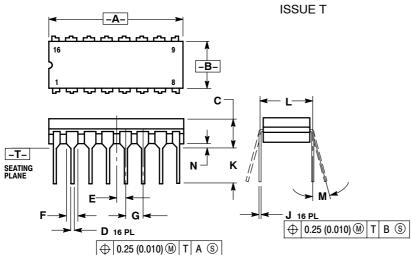


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI

  - DIMENSIONING AND IULEHANGING FER AND 144.5M, 1982.
    CONTROLLING DIMENSION: MILLIMETER.
    DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) DED GINE PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003)
  TOTAL IN EXCESS OF THE LEAD WIDTH
  DIMENSION AT MAXIMUM MATERIAL CONDITION.
  DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE
  BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 ( 0.018).

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α		2.05		0.081	
A <sub>1</sub>	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
С	0.10	0.20	0.007	0.011	
D	9.90	10.50	0.390	0.413	
Е	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
M	0 °	10 °	0 °	10 °	
$Q_1$	0.70	0.90	0.028	0.035	
Z		0.78		0.031	

# CDIP-16 **L SUFFIX** CERAMIC DIP PACKAGE CASE 620-10 **ISSUE T**

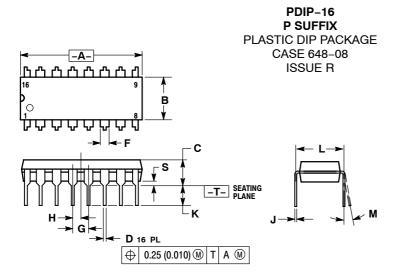


# NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: INCH.
   DIMENSION LTO CENTER OF LEAD WHEN CONTROLLING DIMENSION LTO CENTER OF LEAD WHEN
- DIMENSION 1 TO CENTER OF LEAD WHEN FORMED PARALLEL.
  DIMENSION F MAY NARROW TO 0.76 (0.030)
  WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIMETERS			
DIM	MIN MAX		MIN	MAX		
Α	0.750	0.785	19.05	19.93		
В	0.240	0.295	6.10	7.49		
С		0.200		5.08		
D	0.015	0.020	0.39	0.50		
Е	0.050 BSC		1.27 BSC			
F	0.055	0.065	1.40	1.65		
G	0.100	BSC	2.54 BSC			
Н	0.008	0.015	0.21	0.38		
K	0.125	0.170	3.18	4.31		
L	0.300 BSC		7.62 BSC			
M	0 °	15°	0°	15°		
N	0.020	0.020 0.040		1.01		

#### PACKAGE DIMENSIONS



#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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